





HIS IS A C.A.D. GENERATED DRAWING ON NOT MAKE MANUAL REVISIONS TO MASTER.

ORIGINAL

## **Features**

- CSA Approved and UL Recognized
- .156 (3.96) Contact Spacing x .200 (5.08) Row Spacing
- Accepts .062 (1.57) Nominal Thickness P.C. Board
- High Profile Insulator Body .600 (15.24)
- Contact Termination Options include P.C. Tail, Wire Hole, Wire Wrap, 90 Degree & Extender Board Bends
- Single or Dual Row Configurations
- Large Variety of Mounting Options, Flush or Offset Lugs
- Pre-assembled Card Guides Available
- Accepts Between Contact and In-Contact Polarizing Keys

## **Specifications**

- Insulator Material: DAP
- Contact Material: Copper, Nickel, Tin Alloy CA-725
- Contact Plating: Gold on the Mating Area, Tin on the Contact Tails, Nickel Underplate
- Current Rating: 3 Amperes Continuous
- Contact Resistance: 10 Milliohms Maximum
- Dielectric Withstanding Voltage: 1800 V AC rms at Sea Level Between Adjacent Contacts
- Insulation Resistance: 5000 Megohms Minimum
- Operating Temperature: -65 to +165 Degrees C
- Insertion Force: 16 oz (4.45 N) Maximum per Contact Pair when Tested with a .070 (1.78) Thick Gauge
- Withdrawal Force: 1 oz (0.28 N) Minimum per Contact Pair when Tested with a .054 (1.37) Thick Gauge

837 Series High Temp Card Edge Connector Features and Specifications		ACAD REFERENCE NO. 837 ENG MASTER			
		DRAWN:	J.LEE	DATE: OCT. 06/09	
		CHECKED:		DATE:	
EDAC INC TORONTO, ONTARIO CANADA YOUR CONNECTION TO QUALITY & SERVICE	THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF EDAC INC.,AND SHALL NOT BE REPRODUCED,OR COPIED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS WITHOUT WRITTEN PERMISSION.	SCALE:	NTS	SHEET .	4 OF 4
		DRAWING	NUMBER		ISSUE
		8	37 Assembly		1

## **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

EDAC: 887-018-500-603